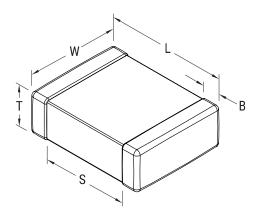
KEMET Part Number: C0805X829B5GAC



SMD Comm C0G Flex, Ceramic, 8.2 pF, +/-0.1 pF, 50 VDC, C0G, SMD, MLCC, FT-CAP, Ultra-Stable, 0805



Dimensions	
Chip Size	0805
L	2mm +/-0.3mm
W	1.25mm +/-0.3mm
Т	0.78mm +/-0.20mm
S	0.75mm MIN
В	0.5mm +/-0.25mm

Packaging Specifications		
Packaging:	Bulk, Bag	
Packaging Quantity:	1	

General Information		
Series:	SMD Comm C0G Flex	
Style:	SMD Chip	
Description:	SMD, MLCC, FT-CAP, Ultra- Stable	
Features:	FT-CAP, Ultra-Stable	
RoHS:	Yes	
Termination:	Flexible Termination	
Marking:	No	
AEC-Q200:	No	
Component Weight:	11 mg	
Shelf Life:	78 Weeks	
MSL:	1	

Specifications		
Capacitance:	8.2 pF	
Measurement Condition:	1 MHz 1.0Vrms	
Capacitance Tolerance:	+/-0.1 pF	
Voltage DC:	50 VDC	
Dielectric Withstanding Voltage:	125 VDC	
Temperature Range:	-55/+125°C	
Temperature Coefficient:	COG	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1MegaHz 1.0Vrms	
Dissipation Factor:	0.1% 1 MHz 1.0Vrms	
Aging Rate:	0% Loss/Decade Hour	
Insulation Resistance:	100 GOhms	

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.



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